502117334 11/05/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Lakshminarayan Viswanathan	09/11/2012
Scott M. Hayes	09/11/2012
Scott D. Marshall	09/11/2012
Mahesh K. Shah	09/11/2012

RECEIVING PARTY DATA

Name:	Freescale Semiconductor, Inc.
Street Address:	6501 William Cannon Drive West
Internal Address:	Law Department
City:	Austin
State/Country:	TEXAS
Postal Code:	78735

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13613979

CORRESPONDENCE DATA

Fax Number: 5128956630

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 512-895-6979

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Correspondent Name: Freescale Semiconductor, Inc.

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ATTORNEY DOCKET NUMBER:	RA48784ZK
NAME OF SUBMITTER:	Shannon Williams
	PATENT

502117334 REEL: 029240 FRAME: 0588

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	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 5		
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PATENT REEL: 029240 FRAME: 0589

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, LAKSHMINARAYAN VISWANATHAN, PHOENIX, AZ; SCOTT M. HAYES, CHANDLER, AZ; SCOTT D. MARSHALL, CHANDLER, AZ; and MAHESH K. SHAH, SCOTTSDALE, AZ; have sold, assigned and transferred, and do hereby sell, assign and transfer. unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in HIGH POWER

SEMICONDUCTOR PACKAGE SUBSYSTEMS (Docket No. RA48784ZK). described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FRESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the

RA48784ZK

inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

Lakshminarayan Viswanathan DATE: Sept 11, 2012

First Witness

ROWALK CARE
SEPT 11, 2012
SIGNATURE OF WITNESS

DATE: Sept 11, 2012
(Month-Day-Year)

RANDY K. COKER
PRINTED NAME OF WITNESS

Second Witness

Date: Set. 11, 2012

SIGNATURE OF WITNESS

David C. Burdeaux

PRINTED NAME OF WITNESS

SCOTT M. HAYES	DATE: Sept 11, 2012
First Witness Kandy Ki Cake SIGNATURE OF WITNESS	DATE: Stpf // 20/2 (Month-Day-Year)
RANDY K. COKER PRINTED NAME OF WITNESS	

Second Witness	
Dat C Buddley SIGNATURE OF WITNESS	DATE: Supt. U Zostz (Month-Day-Year)
David C. Bweleaux PRINTED NAME OF WITNESS	

SCOTT D. MARSHALL	DATE: September 11, 2012
First Witness Randy K. Coker PRINTED NAME OF WITNESS	DATE: Stipt 11, 2012 (Month-Day-Year)

Second Witness	
Dat C Butely SIGNATURE OF WITNESS	DATE: Sept - 11, 7,012 (Month-Day-Year)
David C Burdeaux PRINTED NAME OF WITNESS	

(Maherh KShah MAHESH K. SHAH	DATE: <u>Sept. 11, 12</u>
First Witness Suff SIGNATURE OF WITNESS	DATE: SEP-II- 2012 (Month-Day-Year)
FERNANDO SANTOS PRINTED NAME OF WITNESS	

Second Witness	
SIGNATURE OF WITNESS SVHAIL AGWAN)	DATE: SEP-11-2017(Month-Day-Year)
PRINTED NAME OF WITNESS	

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